nsemi

D

TO247-4LH 15.94x23.45x5.02, 2.54P CASE 340CV **ISSUE B** Е E1 · E4 E3 A D2 · θ S 2x E2 Ì Q θ Dl В ØΡ (D3) ØP1 L2 ł b5 Polish L1 θ b1 b3 A1 **-||-**− c 4x b el \oplus Ø0.25 (M) B A (M) 2x е Section A-A, B-B θ b, b1, b3, b5 **m** ł (c1) С θ 1 (b', b2, b4, b6) NOTE: 1. Dimensioning and tolerancing as per ASME Y14.5 - 2018 Controlling Dimensions = Millimeters 2. 3. Dimensions D and E does not include MOLD FLASH

- 4. Thermal pad contour optional within dimensions D1 and E1
- 5. Lead finish uncontrolled in L1
- ØP to have a max draft angle of 1.5° to the top with MAX. 6. hole diameter of 3.91mm

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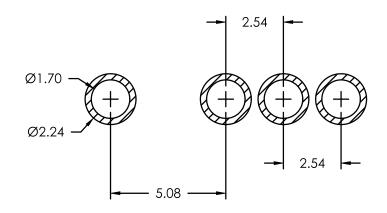
TO247-4LH							
	mm						
SYM	MIN	NOM	MAX				
А	4.80	5.02	5.21				
A1	2.21	2.41	2.61				
A A1 A2 b b'	1.80 1.06	2.00	2.61 2.20 1.36 1.28				
b	1.06	1.20 1.20	1.36				
	1.07	1.20	1.28				
b1	2.33	2.53 1.20	2.94 1.60 2.69				
b3	1.07	1.20	1.60				
b5	2.40	2.54	2.69				
b6	2.39	2.53	2.64				
С	0.51	0.60	0.75				
C'	0.51	0.60	0.72				
c c' D D1	23.30	23.45	23.60 17.65				
	16.25	16.55	17.65				
D2	0.95	1.19	1.25				
D3	8.38 REF						
E	15.74	15.94	16.14				
E1	13.10	14.02	14.32				
E2	3.68	4.40	5.10				
E2 E3	1.00	1.45	14.32 5.10 1.90				
E4	12.38	13.26	13.43				
E5	12.70 REF						
е	2.54 BSC						
el	5.08 BSC						
L	17.27	17.57	17.87				
L1	17.27 3.97	4.19	17.87 4.39				
L2	2.35	2.50	2.65				
ØP	3.40	3.61	3.80				
ØP1	7.19 REF						
Q S	5.49	5.79	6.09				
S	6.04	6.17	6.30				
θ	10°						

DATE 16 APR 2025

TO247-4LH 15.94x23.45x5.02, 2.54P CASE 340CV ISSUE B

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RECOMMENDED PCB THROUGH HOLE



NOTE: LAND PATTERN AND THROUGH HOLE DIMENSIONS SERVE ONLY AS AN INITIAL GUIDE. END-USER PCB DESIGN RULES AND TOLERANCES SHOULD ALWAYS PREVAIL.

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